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(57) Abstract:

The present invention provides a binder clip (100) configured to be used to hold loose documents and covering camera of electronic devices such as laptop, mobile, and the likes. The binder clip (100) includes a clamping mean (102) providing that enables the bonder clip (100) to hold documents. In addition, a shutter assembly (122) provided that facilitates in providing a cover for lens or camera of the electronic devices, the shutter assembly (122) enables the user to move a cover (122) in between a first position and a second position, where in first position the lens of the electronic device is closed by the cover, and in second position the lens of the electronic device is open.

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